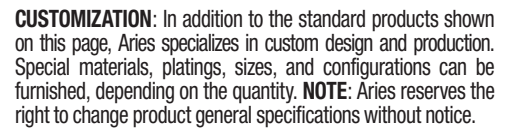




- Allows for breadboarding or substitution of Microgate SOT-23A-6 and SOT-25 IC and transistor packages into 0.100 [2.54] pitch proto boards or PC boards.
- Solder masked top-side pads allow user to hand solder devices directly to topside of adapter with fewer problems of solder bridging.
- Longer male bottom Pins available at special request for easy use of probe clips.
- Large topside pads allow for soldering test pins, jumpers, etc. to top of adapter.

- BOARD MATERIAL: 0.062 [1.58] thick FR-4 manufactured to IPC-600E, Class 2 standards, with 1-oz. Cu traces, both sides
- PADS: HASL
- PINS: Brass 360 1/2-hard per UNS C36000, ASTM B16/B16M
- PIN PLATING: 200μ [5.08μ] Sn/Pb 93/7 ASTM B579-73 over 100μ [2.54μ] Ni per SAE-AMS-QQ-N-290
- OPERATING TEMPERATURE: 221°F [105°C]

- SUGGESTED PCB HOLE SIZE: 0.028 ± 0.003 [0.71 \pm 0.08] dia.



P/N 1110748-P for Panelized Version

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS



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